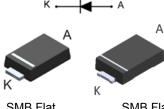


STTH1R06-Y

Datasheet

Automotive 1 A - 600 V turbo 2 ultrafast rectifier



SMB Flat

SMB Flat Wettable leads

Features

- AEC-Q101 qualified
- Ultrafast recovery •
- Low switching losses
- High surge capability •
- Low leakage current •
- High junction temperature
- ECOPACK2 or ECOPACK3 compliant component on demand
- V_{RRM} guaranteed from -40 to +175 °C •

Description

•

The STTH1R06-Y is an ultrafast recovery power rectifier dedicated to energy recovery in automotive application housed in SMB Flat to improve space saving. It is especially designed for clamping function in energy recovery block.

The compromise between forward voltage drop and recovery time offers optimized performances.



Product status link STTH1R06-Y

Product summary				
I _{F(AV)}	1 A			
V _{RRM}	600 V			
T _j (max.)	175 °C			
V _F (typ.)	1.1 V			
T _{rr} (typ.)	30 ns			

1 Characteristics

Table 1. Absolute ratings (limiting values at T_j= 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit
V _{RRM}	Repetitive peak reverse voltage, T_j = -40 to +175 °C	600	V
I _{F(AV)}	Average forward current	1	А
I _{FSM}	Forward surge current	17	А
T _{stg}	Storage temperature range	-65 to + 175	°C
T _j ⁽¹⁾	Operating temperature range	-40 to + 175	°C

1. $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-l)}	Junction to lead	21	°C/W

Table 3. Static electrical characteristic

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	L (1) Deverse lookage surrent		V _R = V _{RRM}	-		1	
IR ⁽¹⁾	Reverse leakage current	T _j = 125 °C	VR - VRRM	-	10	75	μA
VF ⁽²⁾	Forward valtage drap	T _j = 25 °C	I _F = 1 A	-		1.9	V
VF ⁽⁻⁾ FOI	Forward voltage drop	T _j = 150 °C		-	1.1	1.4	

1. Pulsetest: tp = 5 ms, $\delta < 2\%$

2. Pulsetest: $tp = 380 \ \mu s, \ \delta < 2\%$

To evaluate the conduction losses use the following equation:

 $P = 1.1 \text{ x } I_{F(AV)} + 0.30 I_{F^2(RMS)}$

Table 4. Dynamic electrical characteristics

Symbol	Parameter	Test conditions			Тур.	Max.	Unit
t _{rr}	Reverse recovery time	T _j = 25 °C	I_F = 1 A; $dI_{F/dt}$ = -50 A/µs; V_R = 30 V	-	30	45	
t _{fr}	Forward recovery time	Ti = 25 °C	$I_{\rm F}$ = 3 A; dI_{F/dt} = 100 A/µs; V_FR = 3.5 V	-		90	ns
V _{FP}	Forward recovery voltage	1 - 25 0	$I_F = 2 \text{ A}; \text{ d}I_{F/dt} = 100 \text{ A}/\mu\text{s}$	-		8	V

1.1 Electrical characteristics (curves)

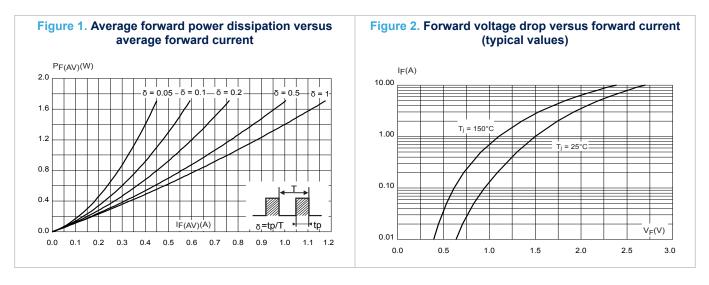


Figure 3. Forward voltage drop versus forward current (maximum values)

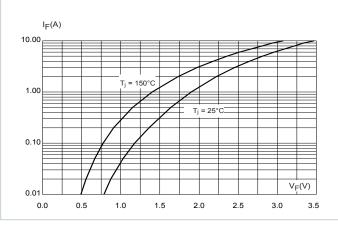
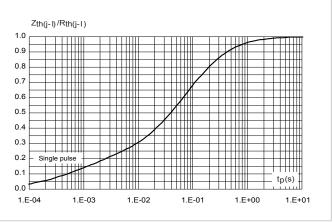
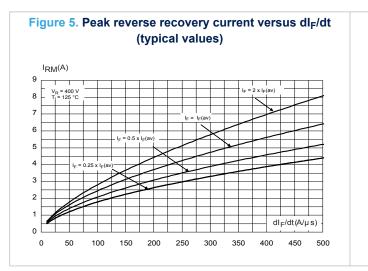
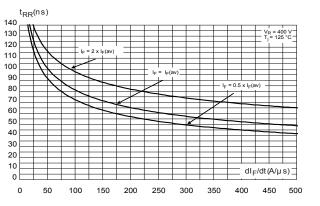


Figure 4. Relative variation of thermal impedance junction to lead versus pulse duration

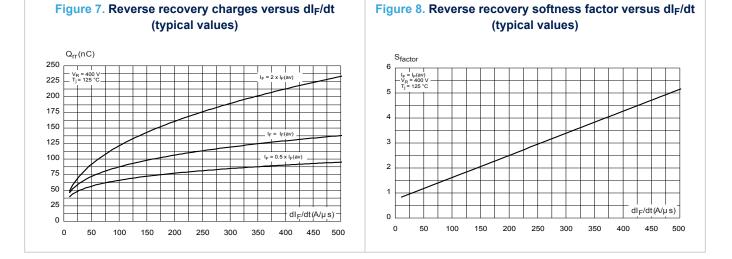


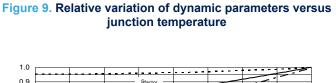


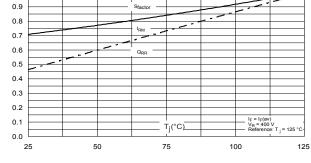




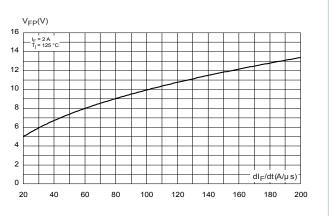


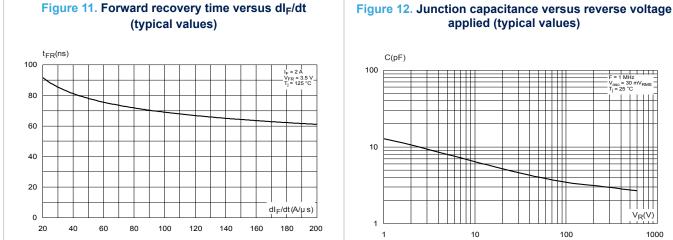
















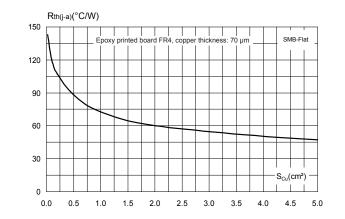


Figure 13. Thermal resistance junction to ambient versus copper surface under each lead

2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 SMB Flat package information

- Epoxy meets UL94, V0
- Lead-free package

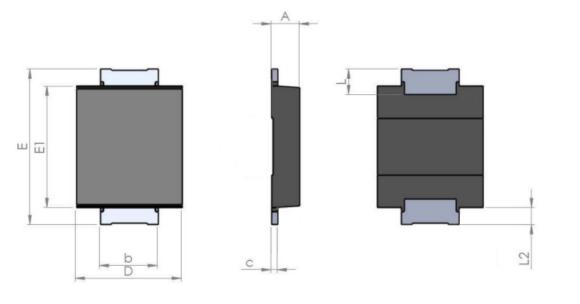
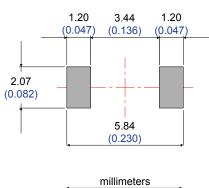


Figure 14. SMB Flat package outline

Table 5. SMB Flat mechanical data

	Dimensions						
Ref.		Millimeters		Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	0.90		1.10	0.035		0.043	
b	1.95		2.20	0.077		0.087	
С	0.15		0.40	0.006		0.016	
D	3.30		3.95	0.130		0.156	
E	5.10		5.60	0.200		0.220	
E1	4.05		4.60	0.159		0.181	
L	0.75		1.50	0.030		0.060	
L2		0.60			0.024		





(inches)



3 Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STTH1R06UFY	F1R6Y	SMBflat	50 mg	5000	Tape and reel

Revision history

Table 6. Document revision history

Date	Version	Changes
04-Aug-2014	1	Initial release.
26-Apr-2022	2	Updated Section 2.1 SMB Flat package information.

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